



# GMF71020

## FAST RECOVERY DIODE MODULE

<b>VOLTAGE UP TO</b>	<b>0 V</b>
<b>AVERAGE CURRENT</b>	<b>200 A</b>
<b>SURGE CURRENT</b>	<b>5 kA</b>

### BLOCKING CHARACTERISTICS

Characteristic	Conditions	Value
VRRM	Repetitive peak reverse voltage	400-800 V
VRSM	Non-repetitive peak reverse voltage	100 V
IRRM	Repetitive peak reverse current, max.	VRRM, single phase, half wave, T <sub>j</sub> = T <sub>jmax</sub>

### FORWARD CHARACTERISTICS

I <sub>F(AV)</sub>	Average forward current	Sine wave, 180° conduction, T <sub>c</sub> = 85°C	200 A
I <sub>F(RMS)</sub>	R.M.S. forward current	Sine wave, 180° conduction, T <sub>c</sub> = 85°C	375 A
I <sub>F(SM)</sub>	Surge forward current	Non rep. half sine wave, 50 Hz, V <sub>R</sub> = 0 V, T <sub>j</sub> = 25 °C	5 kA
I <sup>2</sup> t	I <sup>2</sup> t for fusing coordination		125 kA <sup>2</sup> s
V <sub>FM</sub>	Peak forward voltage, max	Forward current I <sub>F</sub> = 800 A, T <sub>j</sub> = 25 °C	1.5 V

### SWITCHING CHARACTERISTICS

Q <sub>rr</sub>	Reverse recovery charge, typ	T <sub>j</sub> = 25°C, I <sub>F</sub> = 800 A, di/dt = -25 A/μs	100 μC
I <sub>rr</sub>	Reverse recovery current	V <sub>R</sub> = 30 V	130 A
t <sub>rr</sub>	Reverse recovery time		1.5 μs

### THERMAL AND MECHANICAL CHARACTERISTICS

R <sub>th(j-c)</sub>	Thermal resistance (junction to case)		0.16 °C/W
R <sub>th(c-h)</sub>	Thermal resistance (case to heatsink)		0.03 °C/W
T <sub>jmax</sub>	Max operating junction temperature		150 °C
T <sub>stg</sub>	Storage temperature		-40 / 150 °C
M	Mounting torque - Bus bar +/- 10%		10 N·m
M	Mounting torque - Heatsink +/- 10%		6 N·m
mass			100 g